

TOSHIBA Intelligent Power Module Silicon N Channel IGBT

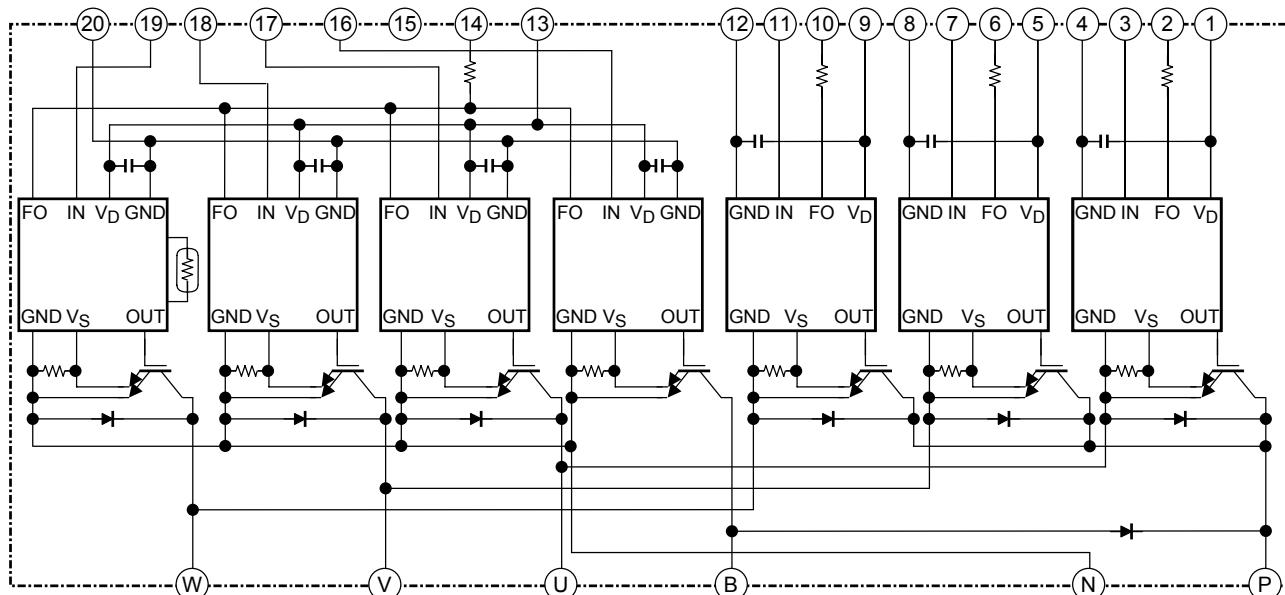
MIG75J7CSB1W (600V/75A 7in1)

High Power Switching Applications

Motor Control Applications

- Integrates inverter, brake power circuit and control circuits (IGBT drive units, and units for protection against short-circuit current, over-current, under-voltage and over-temperature) into a single package.
- The electrodes are isolated from the case
- Low thermal resistance
- V_{CE} (sat) = 1.8 V (typ.)
- UL recognized: File No.E87989
- Weight: 278 g (typ.)

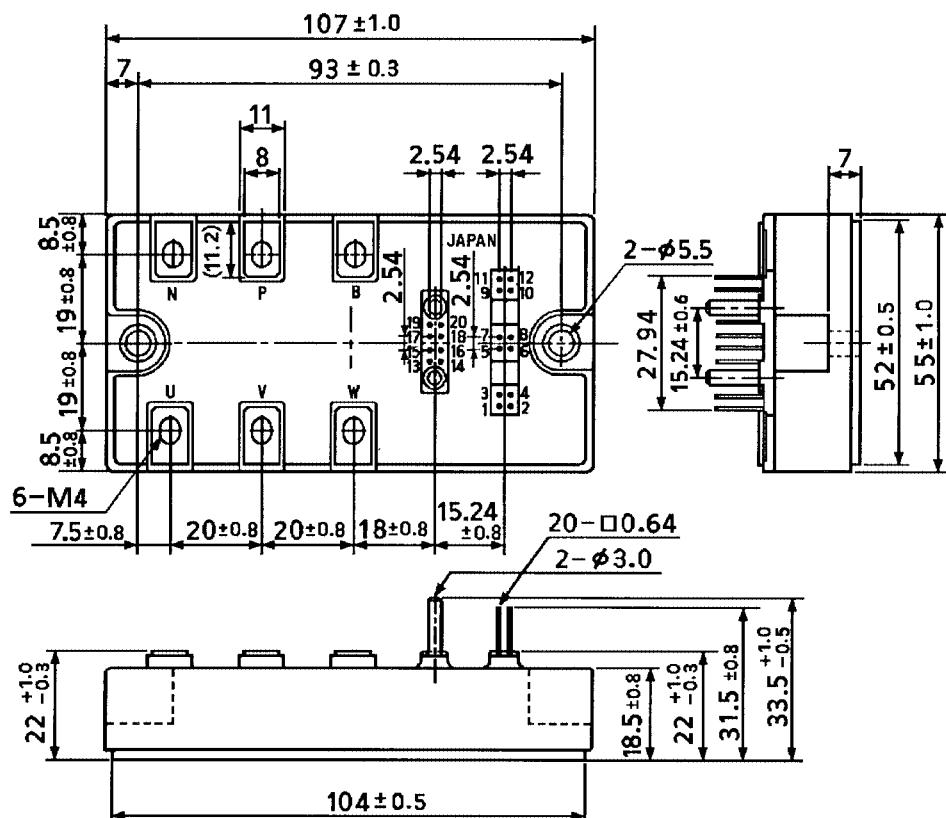
Equivalent Circuit



1.	V _D (U)	2.	FO (U)	3.	IN (U)	4.	GND (U)	5.	V _D (V)	6.	FO (V)	7.	IN (V)
8.	GND (V)	9.	V _D (W)	10.	FO (W)	11.	IN (W)	12.	GND (W)	13.	V _D (L)	14.	FO (L)
15.	Open	16.	IN (B)	17.	IN (X)	18.	IN (Y)	19.	IN (Z)	20.	GND (L)		

Package Dimensions: TOSHIBA 2-108G1A

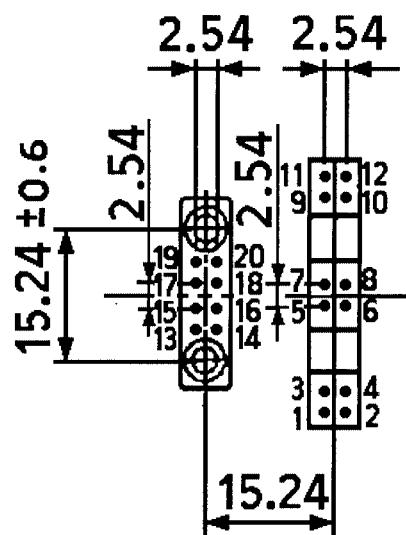
Unit: mm



- | | | | | | |
|---------------|---------------|--------------|--------------|--------------|---------------|
| 1. V_D (U) | 2. FO (U) | 3. IN (U) | 4. GND (U) | 5. V_D (V) | 6. FO (V) |
| 7. IN (V) | 8. GND (V) | 9. V_D (W) | 10. FO (W) | 11. IN (W) | 12. GND (W) |
| 13. V_D (L) | 14. FO (L) | 15. Open | 16. IN (B) | 17. IN (X) | 18. IN (Y) |
| 19. IN (Z) | 20. GND (L) | | | | |

Signal Terminal Layout

Unit: mm



- | | | | | | |
|------------------------|-------------|-----------------------|------------|-----------------------|-------------|
| 1. V _D (U) | 2. FO (U) | 3. IN (U) | 4. GND (U) | 5. V _D (V) | 6. FO (V) |
| 7. IN (V) | 8. GND (V) | 9. V _D (W) | 10. FO (W) | 11. IN (W) | 12. GND (W) |
| 13. V _D (L) | 14. FO (L) | 15. Open | 16. IN (B) | 17. IN (X) | 18. IN (Y) |
| 19. IN (Z) | 20. GND (L) | | | | |

Maximum Ratings ($T_j = 25^\circ\text{C}$)

Stage	Characteristic	Condition	Symbol	Rating	Unit
Inverter	Supply voltage	P-N Power terminal	V_{CC}	450	V
	Collector-emitter voltage	—	V_{CES}	600	V
	Collector current	$T_c = 25^\circ\text{C}$, DC	I_C	75	A
	Forward current	$T_c = 25^\circ\text{C}$, DC	I_F	75	A
	Collector power dissipation	$T_c = 25^\circ\text{C}$, DC	P_C	460	W
	Junction temperature	—	T_j	150	$^\circ\text{C}$
Brake	Supply voltage	P-N Power terminal	V_{CC}	450	V
	Collector-emitter voltage	—	V_{CES}	600	V
	Collector current	$T_c = 25^\circ\text{C}$, DC	I_C	50	A
	Reverse voltage	—	V_R	600	V
	Forward current	$T_c = 25^\circ\text{C}$, DC	I_F	50	A
	Collector power dissipation	$T_c = 25^\circ\text{C}$	P_C	340	W
	Junction temperature	—	T_j	150	$^\circ\text{C}$
Control	Control supply voltage	V_D -GND Terminal	V_D	20	V
	Input voltage	IN-GND Terminal	V_{IN}	20	V
	Fault output voltage	FO-GND Terminal	V_{FO}	20	V
	Fault output current	FO sink current	I_{FO}	14	mA
Module	Operating temperature	—	T_c	$-20 \sim +100$	$^\circ\text{C}$
	Storage temperature range	—	T_{stg}	$-40 \sim +125$	$^\circ\text{C}$
	Isolation voltage	AC 1 min	V_{ISO}	2500	V
	Screw torque (Terminal)	M4	—	2	$\text{N}\cdot\text{m}$
	Screw torque (Mounting)	M5	—	3	

Electrical Characteristics

1. Inverter stage

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Collector cut-off current	I_{CEX}	$V_{CE} = 600 \text{ V}$	$T_j = 25^\circ\text{C}$	—	—	1	mA
			$T_j = 125^\circ\text{C}$	—	—	10	
Collector-emitter saturation voltage	V_{CE} (sat)	$V_D = 15 \text{ V}$ $I_C = 75 \text{ A}$ $V_{IN} = 15 \text{ V} \rightarrow 0 \text{ V}$	$T_j = 25^\circ\text{C}$	1.5	1.8	2.2	V
			$T_j = 125^\circ\text{C}$	—	2.0	—	
Forward voltage	V_F	$I_F = 75 \text{ A}$, $T_j = 25^\circ\text{C}$		—	1.8	2.2	V
Switching time	t_{on}	$V_{CC} = 300 \text{ V}$, $I_C = 75 \text{ A}$ $V_D = 15 \text{ V}$, $V_{IN} = 15 \text{ V} \leftrightarrow 0 \text{ V}$ $T_j = 25^\circ\text{C}$, Inductive load	(Note 1)	—	1.3	2.2	μs
	t_c (on)			—	0.25	—	
	t_{rr}			—	0.2	—	
	t_{off}			—	1.1	2.1	
	t_c (off)			—	0.2	—	

Note 1: Switching time test circuit & timing chart

2. Brake stage

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Collector cut-off current	I_{CEX}	$V_{CE} = 600 \text{ V}$	$T_j = 25^\circ\text{C}$	—	—	1	mA
			$T_j = 125^\circ\text{C}$	—	—	10	
Collector-emitter saturation voltage	$V_{CE} (\text{sat})$	$V_D = 15 \text{ V}$ $I_C = 50 \text{ A}$ $V_{IN} = 15 \text{ V} \rightarrow 0 \text{ V}$	$T_j = 25^\circ\text{C}$	—	1.8	2.2	V
			$T_j = 125^\circ\text{C}$	—	2.0	—	
Reverse current	I_R	$V_R = 600 \text{ V}$	$T_j = 25^\circ\text{C}$	—	—	1	mA
			$T_j = 125^\circ\text{C}$	—	—	10	
Forward voltage	V_F	$I_F = 50 \text{ A}, T_j = 25^\circ\text{C}$		1.5	1.9	2.3	V
Switching time	t_{on}	$V_{CC} = 300 \text{ V}, I_C = 50 \text{ A}$ $V_D = 15 \text{ V}, V_{IN} = 15 \text{ V} \leftrightarrow 0 \text{ V}$ $T_j = 25^\circ\text{C}$, Inductive load	(Note 1)	—	1.3	1.8	μs
	$t_c (\text{on})$			—	0.65	—	
	t_{rr}			—	0.8	—	
	t_{off}			—	1.1	2.1	
	$t_c (\text{off})$			—	0.2	—	

Note 1: Switching time test circuit & timing chart

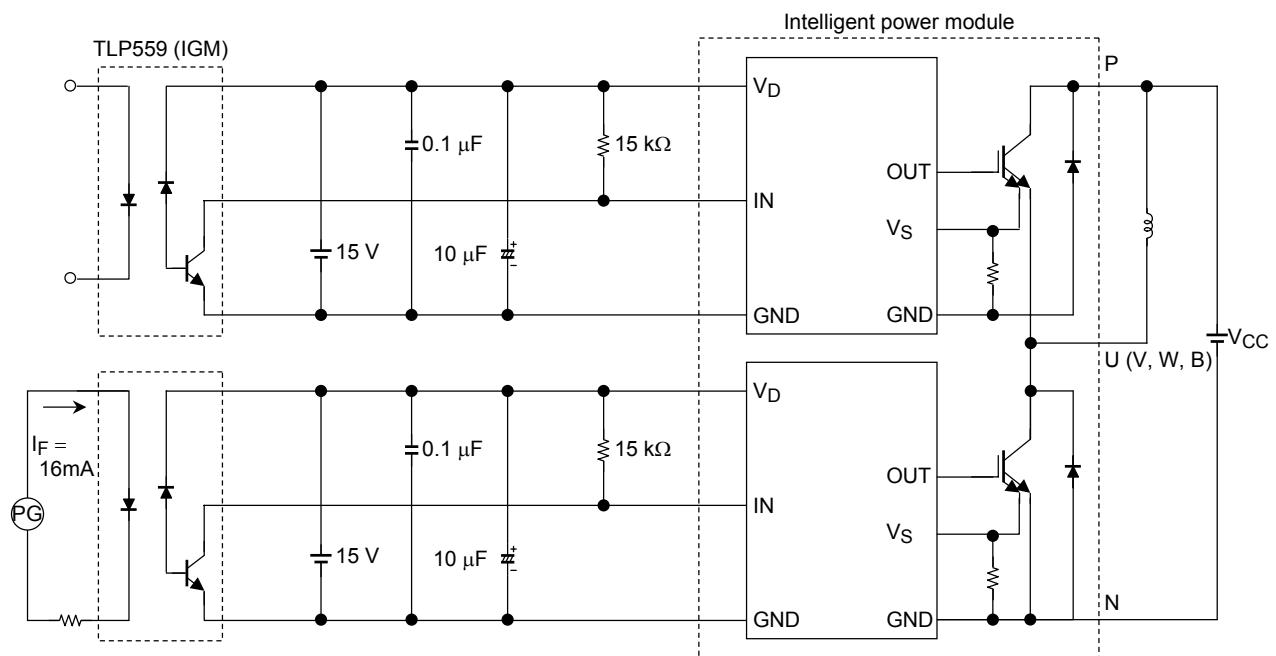
3. Control stage ($T_j = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Control circuit current	High side $I_D (\text{H})$	$V_D = 15 \text{ V}$		—	13	17	mA
	Low side $I_D (\text{L})$			—	52	68	
Input on signal voltage	$V_{IN} (\text{on})$	$V_D = 15 \text{ V}$		1.4	1.6	1.8	V
Input off signal voltage	$V_{IN} (\text{off})$			2.2	2.5	2.8	
Fault output current	Protection $I_{FO} (\text{on})$	$V_D = 15 \text{ V}$		—	10	12	mA
	Normal $I_{FO} (\text{off})$			—	—	0.1	
Over current protection trip level	Inverter	OC	$V_D = 15 \text{ V}, T_j \leq 125^\circ\text{C}$	120	—	—	A
	Brake			80	—	—	
Short circuit protection trip level	Inverter	SC	$V_D = 15 \text{ V}, T_j \leq 125^\circ\text{C}$	120	—	—	A
	Brake			80	—	—	
Over current cut-off time	$t_{off} (\text{OC})$	$V_D = 15 \text{ V}$		—	5	—	μs
Over temperature protection	Trip level OT	Case temperature		110	118	125	$^\circ\text{C}$
	Reset level OTr			—	98	—	
Control supply under voltage protection	Trip level UV	—		11.0	12.0	12.5	V
	Reset level UVr			12.0	12.5	13.0	
Fault output pulse width	t_{FO}	$V_D = 15 \text{ V}$		1	2	3	ms

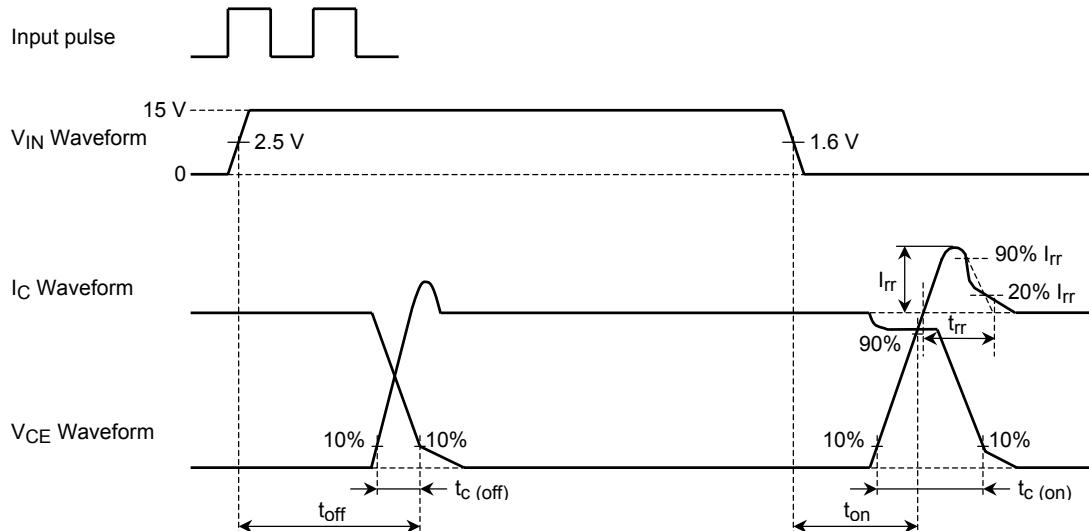
4. Thermal resistance ($T_c = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Junction to case thermal resistance	$R_{th} (\text{j-c})$	Inverter IGBT		—	—	0.270	$^\circ\text{C/W}$
		Inverter FRD		—	—	0.313	
		Brake IGBT		—	—	0.360	
		Brake FRD		—	—	0.600	
Case to fin thermal resistance	$R_{th} (\text{c-f})$	Compound is applied		—	0.017	—	$^\circ\text{C/W}$

Switching Time Test Circuit



Timing Chart

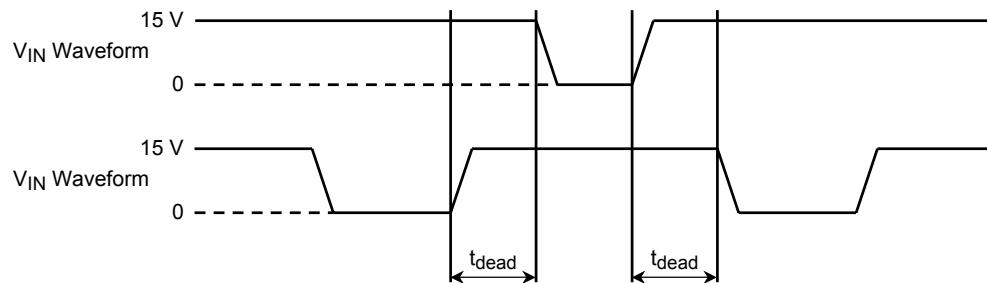


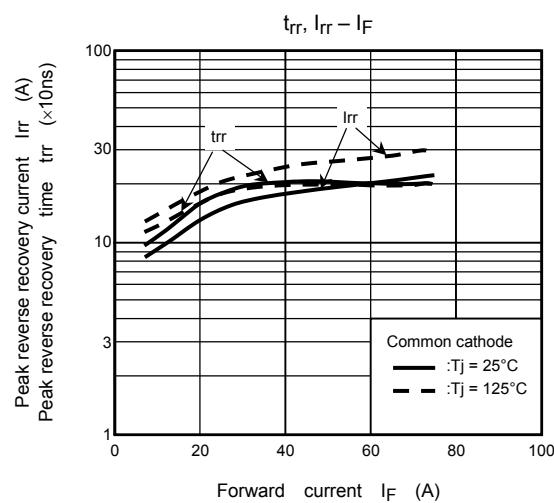
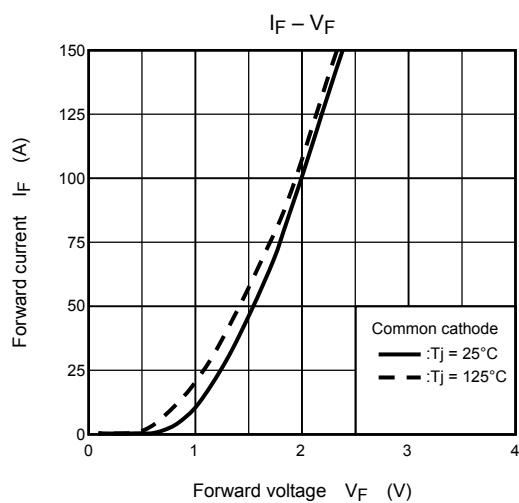
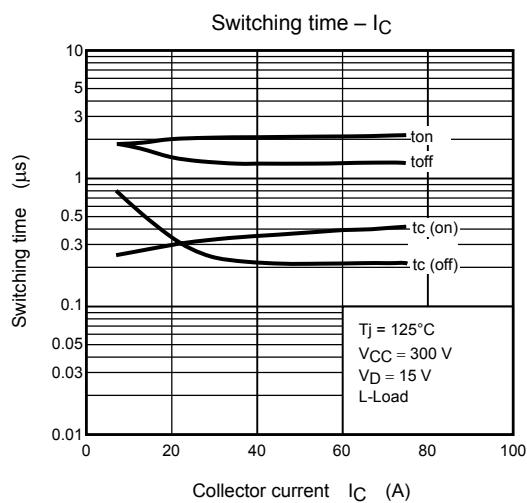
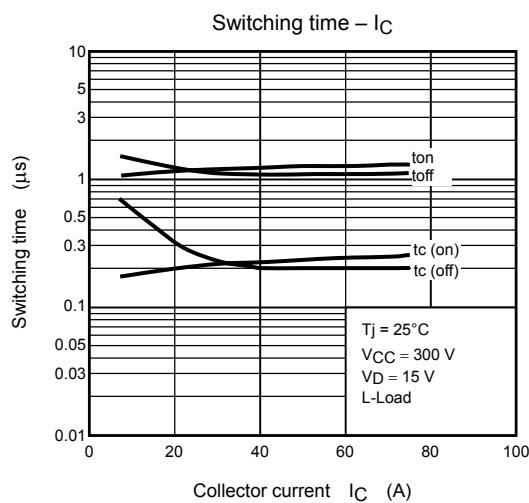
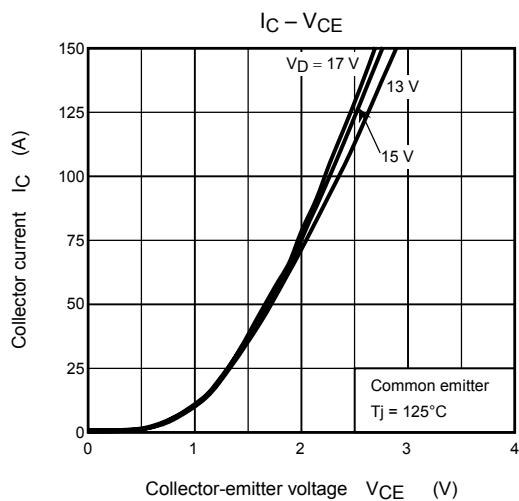
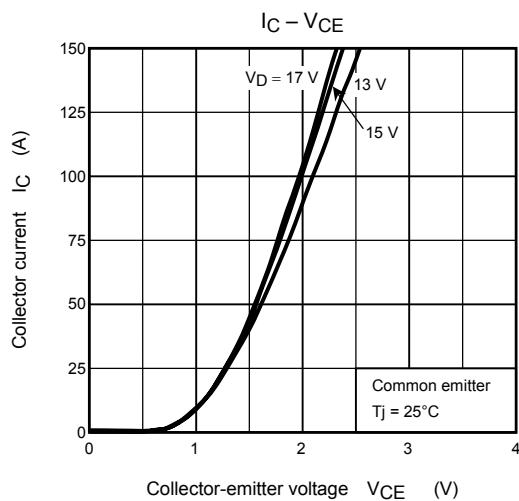
5. Recommended conditions for application

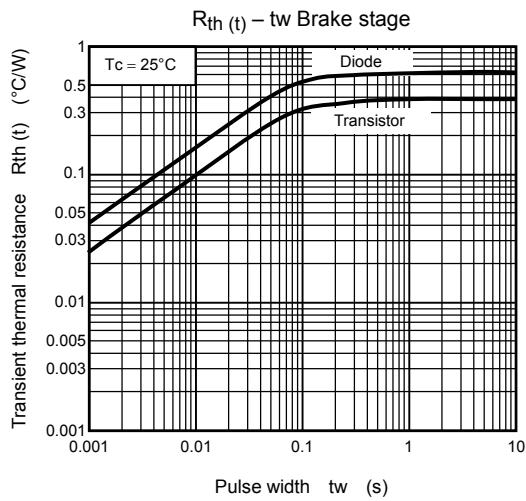
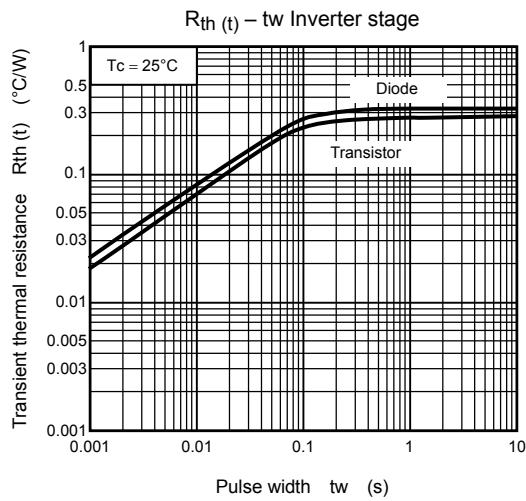
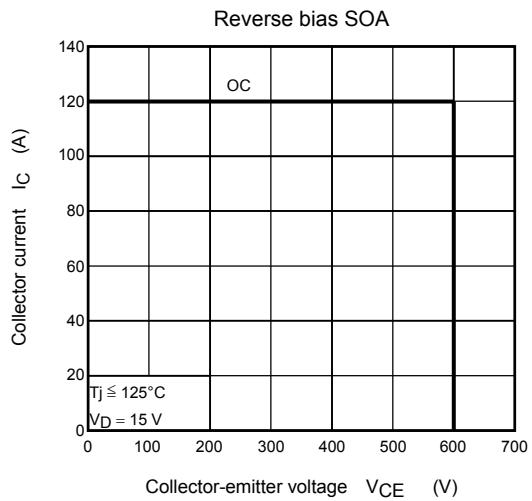
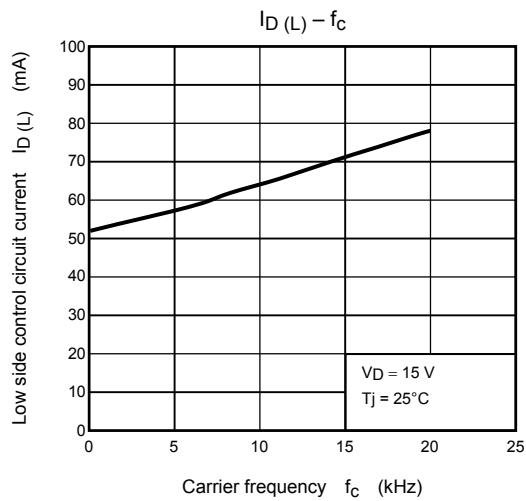
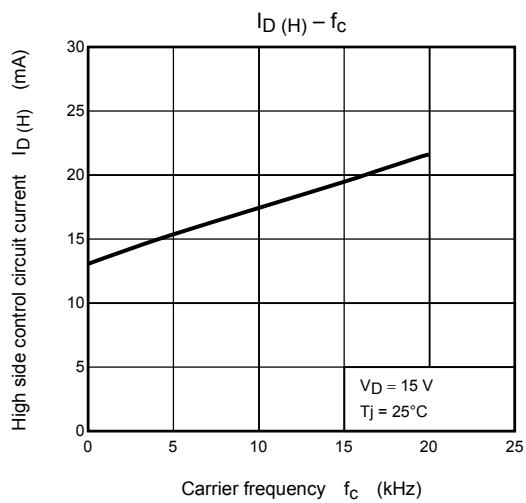
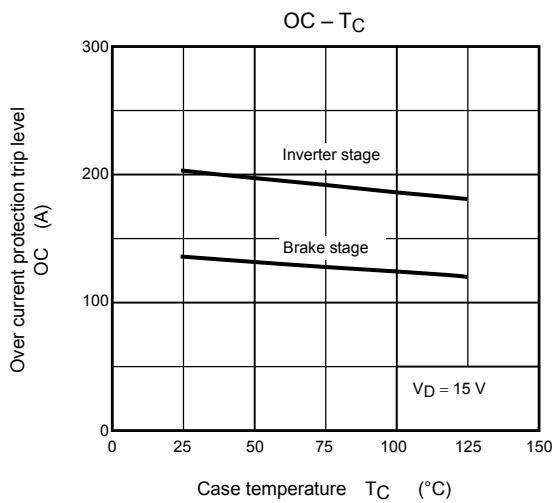
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Supply voltage	V _{CC}	P-N Power terminal	—	300	400	V
Control supply voltage	V _D	V _D -GND Signal terminal	13.5	15	16.5	V
Carrier frequency	f _C	PWM Control	—	—	20	kHz
Dead time	t _{dead}	Switching time test circuit (See page.6)	3	—	—	μs

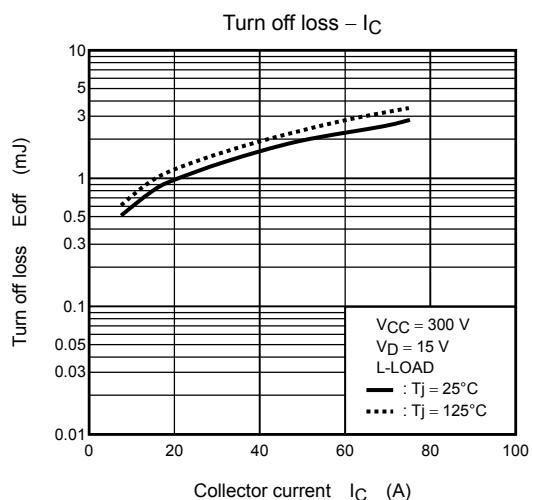
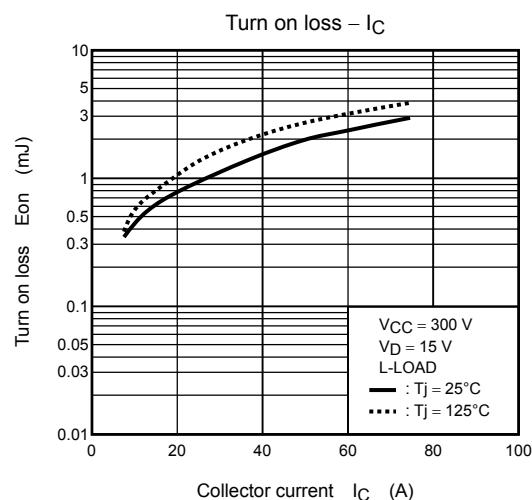
Note 2: The table lists Dead time requirements for the module input, excluding photocoupler delays. When specifying dead time requirements for the photocoupler input, please add photocoupler delays to the dead time given above.

Dead Time Timing Chart









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